GooLED

## GooLED-VOS-4850 Pin Fin LED Heat Sink Φ48mm for Vossloh-Schwabe

Features VS Benefits

* The GooLED-VOS-4850 Vossloh-Schwabe Pin Fin LED Heat Sinks are specifically designed for luminaires using the Vossloh-Schwabe LED engines.

* Mechanical compatibility with direct mounting of the LED engines to the LED cooler and thermal performance matching the lumen packages.

* For spotlight and downlight designs from 500 to 1,600 lumen.

* Thermal resistance range Rth 5.0°C/W.

* Modular design with mounting holes foreseen for direct mounting of Vossloh-Schwabe COB series.

* Diameter 48.0mm - standard height 50.0mm Other heights on request.

* Forged from highly conductive aluminum.

Zhaga LED engine and radiator assembly is a unified future international standardization

* Below you find an overview of Vossloh-Schwabe COB's and LED modules which standard fit on the Pin Fin LED Heat Sinks.

* In this way mechanical after work and related costs can be avoided, and lighting designers can standardize their designs on a limited number of LED Pin Fin LED Heat Sink.
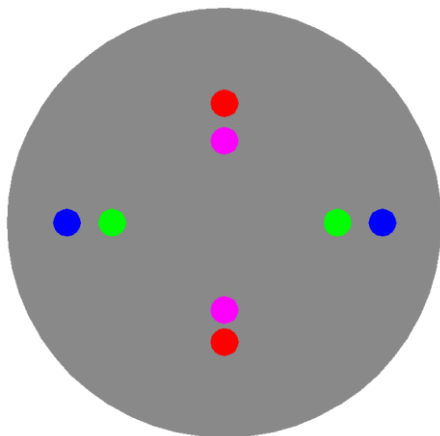
Vossloh-Schwabe LED Modules directly Mounting Options

Vossloh-Schwabe LUGA Shop Gen. 5/ Gen.6 COB Series (13.5*13.5): :

DMS124***H;
DMS123***G;
With the Zhaga Book 11 holders for the green indicator marks.
BJB holder: 47.319.6294.50;
AAG.STUCCHI: 8100-G2
Without the holders for the pink indicator marks.
Direct mounting with machine screws M3x6.5mm.

Vossloh-Schwabe LUGA Shop Gen. 5/ Gen.6 COB Series (19.0*19.0):

DMS124***G;	DMS125***H;
DMS125***G;	DMS126***H;
DMS126***G;	DMS128***H;
DMS128***G;	

Vossloh-Schwabe LUGA Shop TW COB Series:

TW1914;
With the Zhaga Book 3 holders for the blue indicator marks.
BJB holder: 47.319.2021.50;
AAG.STUCCHI: 8101-G2
Without the holders for the red indicator marks.
Direct mounting with machine screws M3x6.5mm.

GooLED

GooLED-VOS-4850 Pin Fin LED Heat Sink Φ48mm for Vossloh-Schwabe

Mounting Options and Drawings & Dimensions

Example:GooLED-VOS-4850-B-1,2

Example:GooLED-VOS-48 `1` - `2` - `3`

`1` **Height (mm)**

`2` **Anodising Color**

B-Black

C-Clear

Z-Custom

`3` **Mounting Options - see graphics for**
details Combinations available

Ex.order code - 12

means option 1 and 2 combined

Notes:

- Mentioned models are an extraction of full product range.

- For specific mechanical adaptations please contact MingfaTech.

- MingfaTech reserves the right to change products or specifications without prior notice.

MOUNTING OPTION	Module type	Holder NO.	THREAD	THREAD DEPTH	THREAD HOLE DISTANCE
1	COB series (13.5*13.5)	/	M3	6.5mm	19.0mm/ 2-@180°
2		BJB Holder 47.319.6294.50	M3	6.5mm	25.0mm/ 2-@180° (Zhaga book 11)
		AAG.STUCCHI 8100-G2			
3	COB series (19.0*19.0)	/	M3	6.5mm	26.8mm/ 2-@180°
4		BJB Holder 47.319.2021.50			35.0mm/ 2-@180° (Zhaga book 3)
		AAG.STUCCHI 8101-G2			

Tel:+86-769-39023131
Fax:+86-(020)28819702   ext:22122
Email:sales@mingfatech.com
Http://www.heatsinkled.com
Http://www.mingfatech.com

Mingfa Tech

2
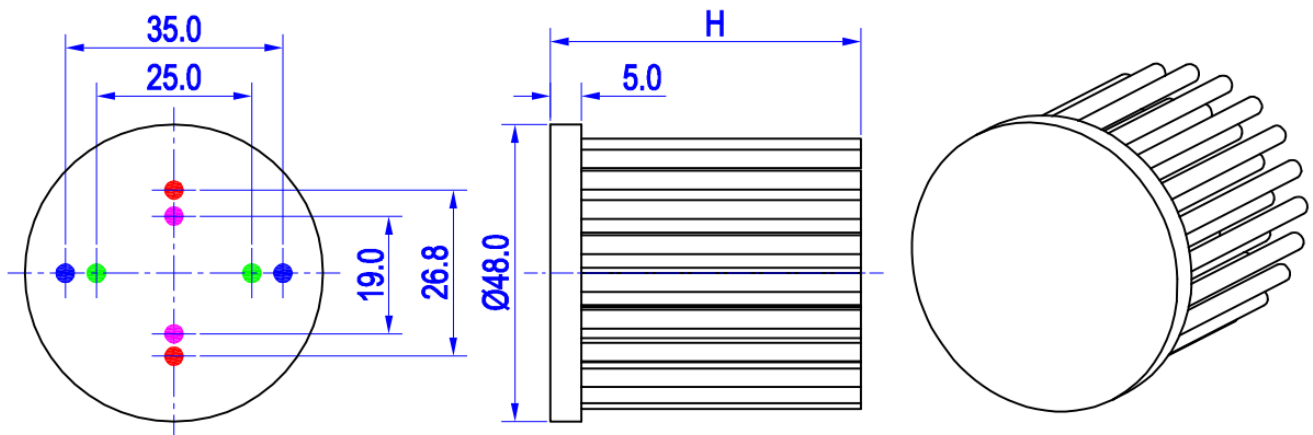
GooLED

GooLED-VOS-4850 Pin Fin LED Heat Sink Φ48mm for Vossloh-Schwabe

The product deta table

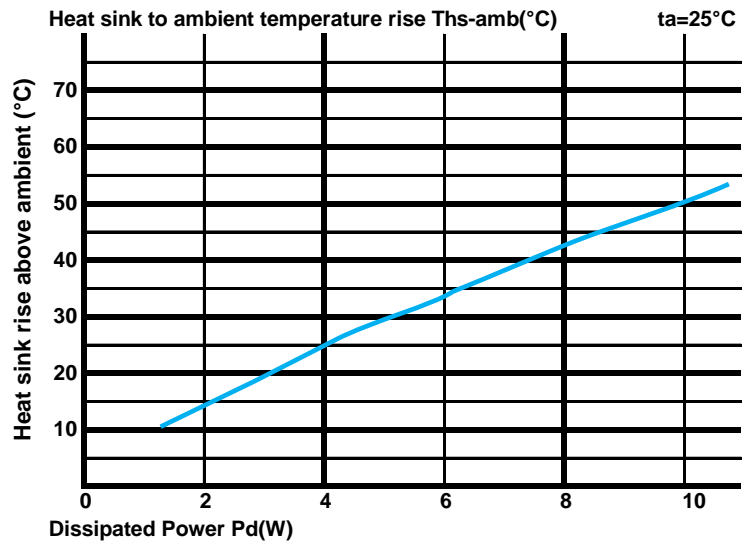| Model No.	GooLED-VOS-4850
Heatsink Size	Φ48xH50mm
Heatsink Material	AL1070
Finish	Black Anodized
Weight (g)	64.0
Dissipated power (Ths-amb,50℃)	10.0 (W)
Cooling surface area (mm²)	24285
Thermal Resistance (Rhs-amb)	5.0 (°C/W)

The thermal data table

* Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.

*To calculate the dissipated power please use the following formula: Pd = Pe x (1-ηL).

Pd - Dissipated power ; Pe - Electrical power ; ηL = Light effciency of the LED module;

Pd = Pe x (1-ηL)		Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
		GooLED-VOS-4850	
Dissipated Power Pd(W)	2.0	7.00	14.0
	4.0	6.25	25.0
	6.0	5.67	34.0
	8.0	5.38	43.0
	10.0	5.00	50.0

Heat sink to ambient temperature rise Ths-amb(°C)   **ta=25°C**

*The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).

MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.

Either thermal grease,A thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended.

*Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow.

Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (Ths-Ta)/Pd$

θ - Thermal Resistance [°C/W] ; Ths - Heatsink temperature ; Ta - Ambient temperature ;

*The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is $R_{junction-case}$, the thermal resistance of the TIM outside the package is $R_{interface (TIM)}$ [°C/W], the thermal resistance with the heat sink is $R_{heatsink-ambient}$ [°C/W], and the ambient temperature is $T_{ambient}$ [°C].

*Thermal resistances outside the package $R_{interface (TIM)}$ and $R_{heatsink-ambient}$ can be integrated into the thermal resistance $R_{case-ambient}$ at this point.Thus, the following formula is also used:

$T_{junction} = (R_{junction-case} + R_{case-ambient}) \cdot Pd + T_{ambient}$